

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor FCI25N60N_F102

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



FAIRCHILD

SEMICONDUCTOR®

FCI25N60N N-Channel SupreMOS[®] MOSFET 600 V, 25 A, 125 mΩ

Features

- $R_{DS(on)}$ = 107 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 12.5 A
- Ultra Low Gate Charge (Typ. Q_g = 57 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 262 pF)
- 100% Avalanche Tested
- RoHS Compliant

Application

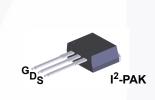
- Solar Inverter
- AC-DC Power Supply

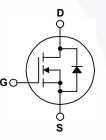
November 2013

FCI25N60N — N-Channel SupreMOS[®] MOSFET

Description

The SupreMOS[®] MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCI25N60N_F102	Unit		
V _{DSS}	Drain to Source Voltage		600	V	
V _{GSS}	Gate to Source Voltage		±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)	25	A	
		- Continuous (T _C = 100 ^o C)	16		
I _{DM}	Drain Current	- Pulsed (Note) 75	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2) 861	mJ	
I _{AR}	Avalanche Current (Note 1)		8.3	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.2	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/d	3) 15			
P _D	Power Dissipation	(T _C = 25°C)	216	W	
		- Derate Above 25°C	1.72	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

Thermal Characteristics

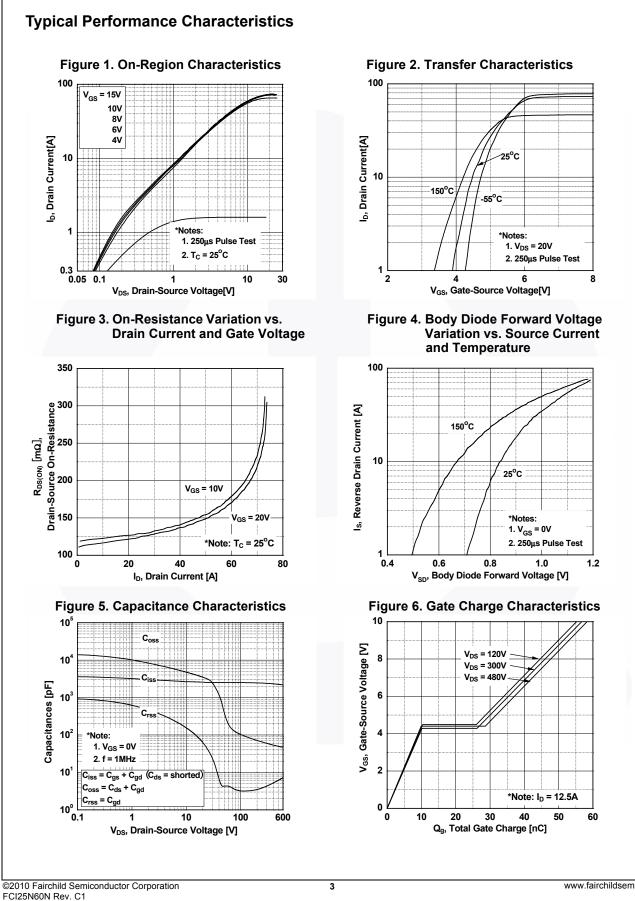
Symbol	Parameter	FCI25N60N_F102	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.58	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	0/11



haracteristics T _C = 25°C Parameter stics ain to Source Breakdown Voltage eakdown Voltage Temperature befficient ro Gate Voltage Drain Current	e ID	Test Conditio = 1 mA, V _{GS} = 0 V,T _J	_J = 25 ^o C	Min. 600	Тур.	Max.	Uni
Parameter stics ain to Source Breakdown Voltage eakdown Voltage Temperature pefficient	e ID	Test Conditio = 1 mA, V _{GS} = 0 V,T _J	_J = 25 ^o C				Uni
ain to Source Breakdown Voltage eakdown Voltage Temperature pefficient	I _D			600	-		
ain to Source Breakdown Voltage eakdown Voltage Temperature pefficient	I _D			600	-		
eakdown Voltage Temperature	I _D			600	-		1/
pefficient	_	= 1 mA, Referenced t	- 0500	600	-	-	V
ro Gate Voltage Drain Current		$I_D = 1 \text{ mA}$, Referenced to 25° C			0.74	-	V/ºC
ro Gate voltage Drain Current		V _{DS} = 480 V, V _{GS} = 0 V		-	-	10	
C C	V _D	$V_{DS} = 480 \text{ V}, \text{ T}_{J} = 125^{\circ}\text{C}$			-	100	μA
Gate to Body Leakage Current		$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$			-	±100	nA
stics							
ate Threshold Voltage	Vc	V _{CS} = V _{DS} . I _D = 250 µA			-	4.0	V
			-	0.107	0.125	Ω	
rward Transconductance				-		-	S
acteristics							•
					2520	2252	~5
		_{DS} = 100 V, V _{GS} = 0 V	Ι,				pF pF
	f =	f = 1 MHz				-	pF
•	Vr	$r_{re} = 380 \text{ V} \text{ V}_{ce} = 0 \text{ V}$	/ f = 1 MHz			-	pF
				-		-	pF
					57	74	nC
ate to Source Gate Charge			^ ,	-	10	-	nC
ate to Drain "Miller" Charge			(Note 4)	-	18	-	nC
uivalent Series Resistance (G-S)	f =	1 MHz		-	1	-	Ω
aracteristics							
				-	21	52	ns
,	Vr	$V_{DD} = 380 \text{ V, } I_D = 12.5 \text{ A,} \\ V_{GS} = 10 \text{ V, } R_G = 4.7 \Omega$		-			ns
	Ve			-	68	146	ns
rn-Off Fall Time	(Note 4)		(Note 4)	-	5	20	ns
Diode Characteristics	I			1			
	ce Diode Fr			_		25	А
					_		A
				-	-	1.2	V
verse Recovery Time				-	370	-	ns
verse Recovery Charge			,	-	7	-	μC
	ate Threshold Voltage atic Drain to Source On Resistand inward Transconductance acteristics but Capacitance itput Capacitance itput Capacitance itput Capacitance itput Capacitance itput Capacitance itective Output Capacitance atal Gate Charge at 10V ite to Source Gate Charge ite to Drain "Miller" Charge uivalent Series Resistance (G-S) aracteristics rm-On Delay Time rm-On Rise Time rm-Off Delay Time rm-Off Fall Time Diode Characteristics ximum Continuous Drain to Source Dia ain to Source Diode Forward Volta verse Recovery Time	ate Threshold Voltage V _G ate Tansconductance V _G ate transfer Capacitance V _G tective Output Capacitance V _G tet to Source Gate Charge V _G tet to Drain "Miller" Charge V _G uivalent Series Resistance (G-S) f = aracteristics m-On Delay Time m-On Rise Time V _G m-Off Delay Time V _G m-Off Fall Time V _G ximum Continuous Drain to Source Diode Forward V _G ximum Pulsed Drain to Source Diode Forward V _G verse Recovery Time V _G	ate Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ atic Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 12.5 \ A$ atic Drain to Source On Resistance $V_{DS} = 20 \ V$, $I_D = 12.5 \ A$ acteristics $V_{DS} = 20 \ V$, $I_D = 12.5 \ A$ acteristics $V_{DS} = 100 \ V$, $V_{GS} = 0 \ V$ acteristics $V_{DS} = 100 \ V$, $V_{GS} = 0 \ V$ acteristics $V_{DS} = 100 \ V$, $V_{GS} = 0 \ V$ acteristics $V_{DS} = 380 \ V$, $V_{GS} = 0 \ V$ acteristics $V_{DS} = 380 \ V$, $V_{GS} = 0 \ V$ acteristics $V_{DS} = 380 \ V$, $I_D = 12.5 \ V_{GS} = 10 \ V$ acteristics $V_{DS} = 380 \ V$, $I_D = 12.5 \ V_{GS} = 10 \ V$ acteristics $V_{DS} = 10 \ V$ aracteristics $V_{DD} = 380 \ V$, $I_D = 12.5 \ V_{GS} = 10 \ V$ aracteristics $V_{DD} = 380 \ V$, $I_D = 12.5 \ V_{GS} = 10 \ V$, $V_{GS} = 10 \ V$, $R_G = 4.7 \ \Omega$ aracteristics $V_{DD} = 380 \ V$, $I_D = 12.5 \ V_{GS} = 10 \ V$, $R_G = 4.7 \ \Omega$ aracteristics $V_{DD} = 380 \ V$, $I_D = 12.5 \ V_{GS} = 10 \ V$, $R_G = 4.7 \ \Omega$ aracteristics $V_{DD} = 380 \ V$, $I_D = 12.5 \ V_{CS} = 10 \ V$, $R_G = 4.7 \ \Omega$ aracteristics $V_{DD} = 380 \ V$, $I_D = 12.5 \ V$ aracteristics $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$ aracteristics $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$ aracteristics $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$ aracteristics $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$ aracteristics $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$ aracteristics $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$ arac	ate Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ atic Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 12.5 \ A$ inward Transconductance $V_{DS} = 20 \ V$, $I_D = 12.5 \ A$ invard Transconductance $V_{DS} = 20 \ V$, $I_D = 12.5 \ A$ into Capacitance $V_{DS} = 100 \ V$, $V_{GS} = 0 \ V$,into Capacitance $V_{DS} = 100 \ V$, $V_{GS} = 0 \ V$,into Capacitance $V_{DS} = 380 \ V$, $V_{GS} = 0 \ V$,into Capacitance $V_{DS} = 380 \ V$, $V_{GS} = 0 \ V$ into Capacitance $V_{DS} = 380 \ V$, $I_D = 12.5 \ A$,into Capacitance $V_{DS} = 380 \ V$, $I_D = 12.5 \ A$,into Capacitance $V_{DS} = 10 \ V$ into Source Gate Charge $V_{GS} = 10 \ V$ into Source Gate Charge $V_{CS} = 10 \ V$ into Continuous Drain to Source Diode Forward Currentinto Source Diode Forward Voltageinto Source Diode Forward Voltage $V_{GS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 10 \ V$, $R_G = 4.7 \ \Omega$ into Source Diode Forward Currentinto Source Diode Forward Currentinto Source Diode Forward Currentinto Source Diode Forward Currentinto Source Diode Forward Voltage $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$, $V_{CS} = 0 \ V$, $I_{SD} = 12.5 \ A$,	the Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ 2.0atic Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 12.5 \ A$ -rward Transconductance $V_{DS} = 20 \ V$, $I_D = 12.5 \ A$ -racteristicsbut Capacitance $V_{DS} = 100 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz-recteristicstype active capacitance $V_{DS} = 380 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz-type active capacitance $V_{DS} = 380 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz-tective Output Capacitance $V_{DS} = 380 \ V$, $V_{GS} = 0 \ V$ -tal Gate Charge at 10V $V_{DS} = 380 \ V$, $I_D = 12.5 \ A$,-tet to Source Gate Charge $V_{GS} = 10 \ V$ -uivalent Series Resistance (G-S)f = 1 MHz-m-On Delay Timem-On Rise Time $V_{DD} = 380 \ V$, $I_D = 12.5 \ A$,-m-Off Delay Timem-Off Fall Time(Note 4)-Diode Characteristicsximum Continuous Drain to Source Diode Forward Current-ximum Pulsed Drain to Source Diode Forward Current-ain to Source Diode Forward Current-ain to Source Diode Forward Voltage $V_{GS} = 0 \ V, I_{SD} = 12.5 \ A,$ -verse Recovery Time $V_{GS} = 0 \ V, I_{SD} = 12.5 \ A,$ -	tate Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ 2.0atic Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 12.5 \ A$ -0.107invard Transconductance $V_{DS} = 20 \ V$, $I_D = 12.5 \ A$ -0.107acteristicsacteristicsacteristicsvarce in the colspan="2">of the colspan="2">2520invard TransconductanceV _{DS} = 100 V, $V_{GS} = 0 \ V$, $I_D = 12.5 \ A$ acteristicsacteristicsvarce in the colspan="2">2520of the colspan="2">2520invard TransconductanceV _{DS} = 100 V, $V_{GS} = 0 \ V$, $I_D = 12.5 \ A$ acteristicsverse Transfer CapacitanceV _{DS} = 380 V, $V_{GS} = 0 \ V$, $f = 1 \ MHz$ -100 VV_DS = 380 V, $I_D = 12.5 \ A$,-(Note 4)-100 VV_DS = 10 V(Note 4)-2.1-(Note 4)-10 V(Note 4)-10 V(Note 4)-10 V(Note 4)-2.1-<	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

FCI25N60N — N-Channel SupreMOS[®] MOSFET

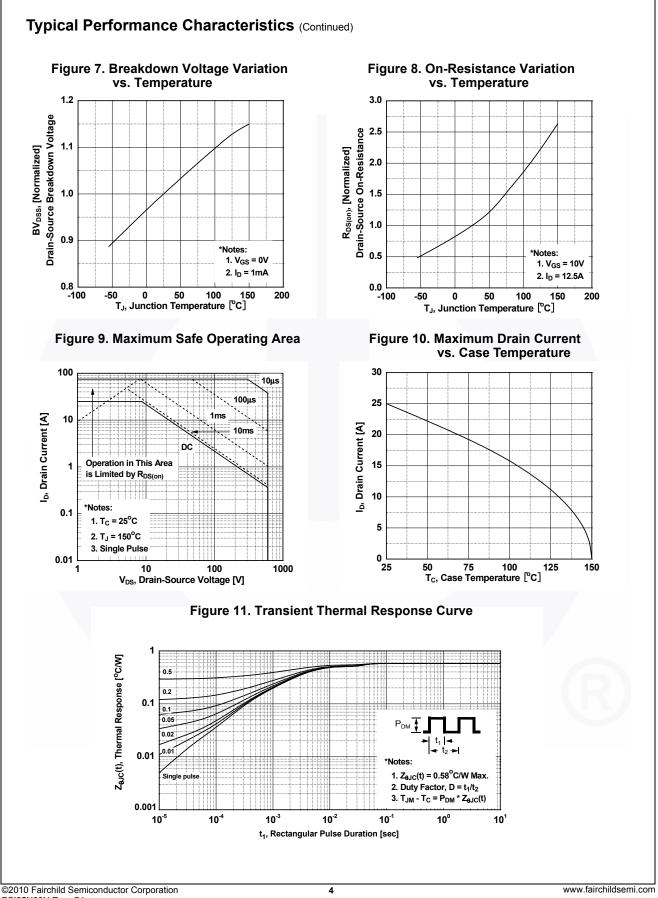




FCI25N60N — N-Channel SupreMOS[®] MOSFET

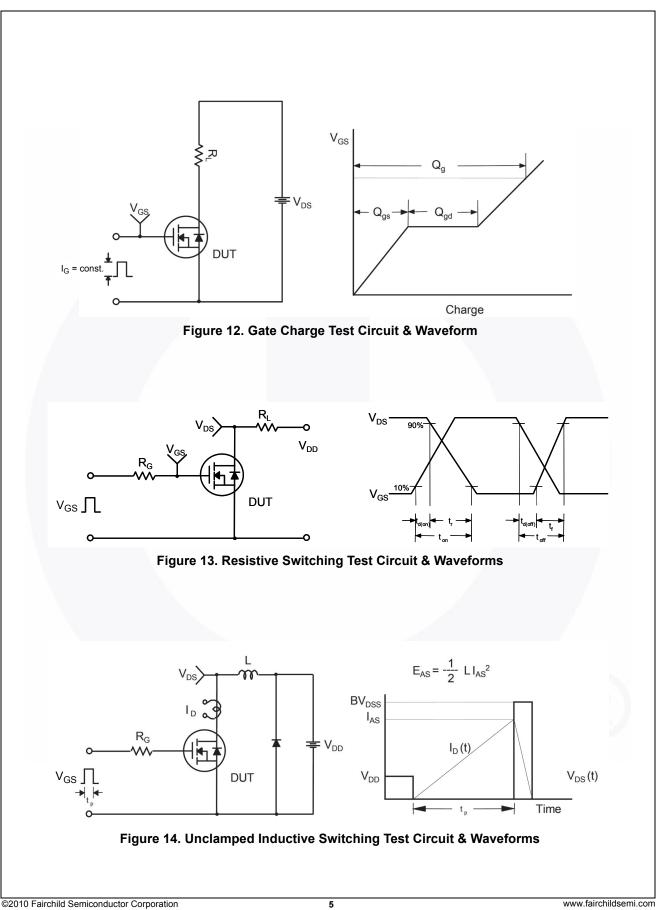


FCI25N60N — N-Channel SupreMOS[®] MOSFET



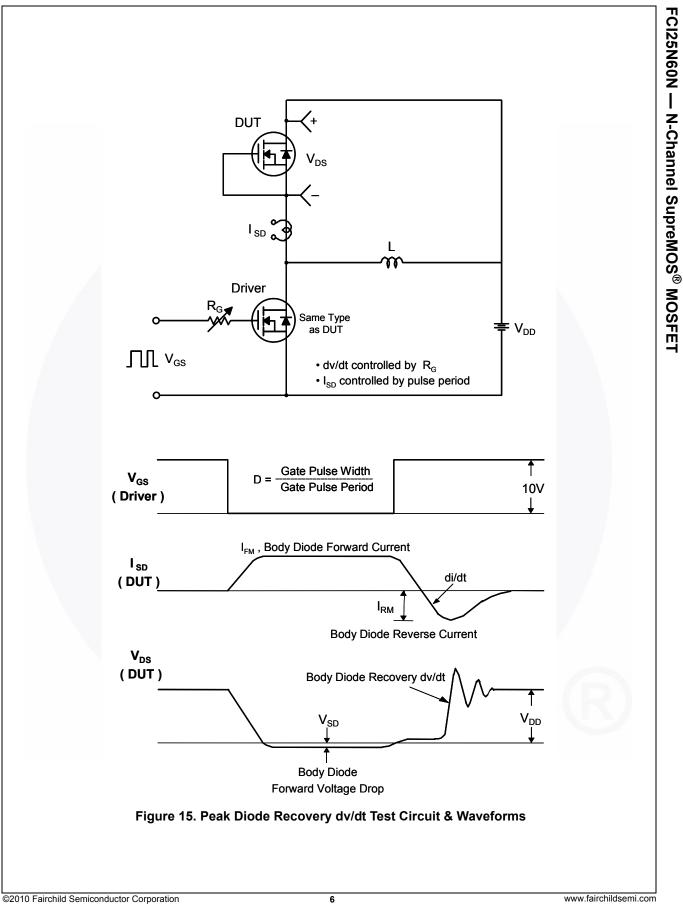
FCI25N60N Rev. C1



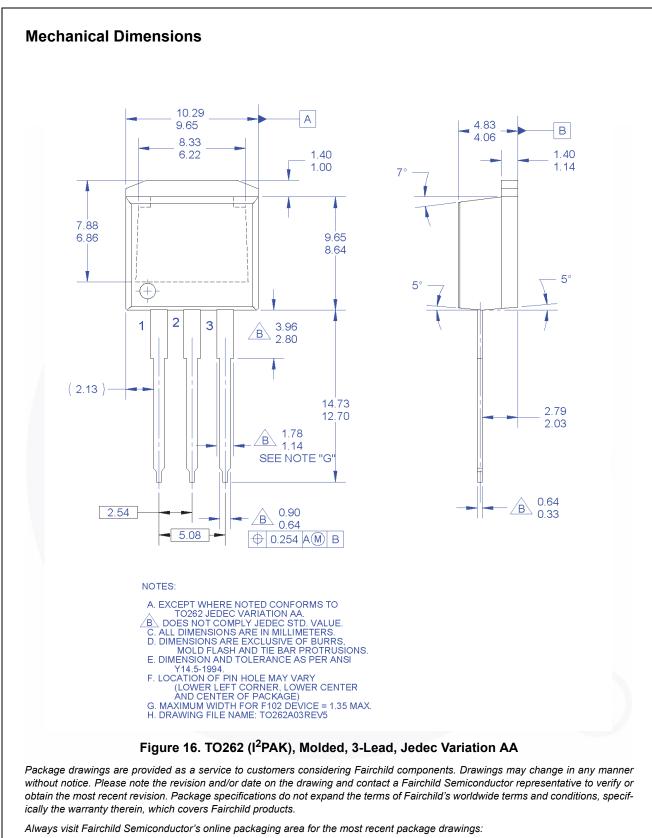


FCI25N60N — N-Channel SupreMOS[®] MOSFET









http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT262-013

FCI25N60N — N-Channel SupreMOS[®] MOSFET



FAIRCHILD SEMICONDUCTOR TRADEMARKS The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks. AccuPower™ AX-CAP[®]* E-PES™ Sync-Lock™ FRFET® SYSTEM ®* BitSiC™ Global Power ResourceSM PowerTrench[®] Green FPS™ Build it Now™ PowerXS™ TinyBoost Programmable Active Droop™ CorePLUS™ TinyBuck[®] CorePOWER™ Green FPS™ e-Series™ **OFET**[®] TinyCalc™ Gmax™ QS™ CROSSVOLT™ TinyLogic® GTO™ Quiet Series™ **TINYOPTO™** IntelliMAX™ Current Transfer Logic™ RapidConfigure ™ TinvPower™ ISOPLANAR™ DEUXPEED® TinyPWM™ Marking Small Speakers Sound Louder Dual Cool™ TinyWire™ EcoSPARK[®] and Better™ Saving our world, 1mW/W/kW at a time™ TranSiC™ MegaBuck™ EfficentMax™ SignalWise[™] TriFault Detect™ SmartMax™ ESBC™ MICROCOUPLER™ TRUECURRENT®* MicroFET™ SMART START™ µSerDes™ R Solutions for Your Success™ SPM[®] MicroPak™ $\mu_{_{
m Seri}}$ MicroPak2™ Fairchild® Fairchild Semiconductor® MillerDrive[™] STEALTH™ SuperFET[®] SuperSOT™-3 UHC® FACT Quiet Series™ MotionMax[™] Ultra FRFET™ FACT[®] FAST[®] mWSaver OptoHiT™ SuperSOT™-6 UniFET™ VCX™ **OPTOLOGIC®** SuperSOT™-8 FastvCore™ SupreMOS[®] VisualMax™ **OPTOPLANAR®** FETBench™ VoltagePlus™ XS™ SvncFET™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

CTL™

F

FPS™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

FCI25N60N — N-Channel SupreMOS[®] MOSFE

©2010 Fairchild Semiconductor Corporation FCI25N60N Rev. C1